## PRELIMINARY INFORMATION (subject to change without notice) March 30, 1999



Pinning is shown viewed from branded side.

## ABSOLUTE MAXIMUM RATINGS at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$

Supply Voltage, $\mathrm{V}_{\mathrm{CC}}$........................ 26.5 V
Reverse Battery Voltage, $\mathrm{V}_{\text {RCC }}$.......... - $\mathbf{3 0} \mathrm{V}$
Magnetic Flux Density, B ........... Unlimited
Output OFF Voltage, V ${ }_{\text {Out }}$................. 26 V
Continuous Output Current,
$\mathrm{I}_{\text {out }}$. Internally Limited
Reverse Output Current, $\mathrm{I}_{\text {OUt }}$......... $\mathbf{- 5 0} \mathbf{~ m A}$ Package Power Dissipation, $\mathrm{P}_{\mathrm{D}}$. See Graph
Junction Temperature, $\mathrm{T}_{\mathrm{J}} . . . . . . . . . . . . . .+\mathbf{1 7 0}^{\circ} \mathbf{C}$
Operating Temperature Range, $\mathrm{T}_{\mathrm{A}}$
Suffix 'E- $\qquad$ $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
Suffix 'L-' ................ $-\mathbf{4 0}{ }^{\circ} \mathbf{C}$ to $+\mathbf{1 5 0}{ }^{\circ} \mathrm{C}$ Storage Temperature Range,
$\mathrm{T}_{\mathrm{S}}$
$-65^{\circ} \mathrm{C}$ to $+170^{\circ} \mathrm{C}$

## CHOPPER-STABILIZED, PRECISION HALL-EFFECT SWITCH

The A3240-- Hall-effect switch is an extremely temperature-stable and stress-resistant sensor especially suited for operation over extended temperature ranges to $+150^{\circ} \mathrm{C}$. Superior high-temperature performance is made possible through dynamic offset cancellation, which reduces the residual offset voltage normally caused by device overmolding, temperature dependencies, and thermal stress.

The device includes on a single silicon chip a voltage regulator, Hall-voltage generator, small-signal amplifier, chopper stabilization, Schmitt trigger, and a short-circuit protected open-collector output to sink up to 25 mA . A south pole of sufficient strength will turn the output ON. An on-board regulator permits operation with supply voltages of 4.2 to 24 volts.

The first character of the part number suffix determines the device operating temperature range; suffix ' $\mathrm{E}-$ ' is for $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$ and ${ }^{\prime} \mathrm{L}-$ ' is $-40^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$. Three package styles provide a magnetically optimized package for most applications. Suffix ' - LH' is a modified SOT-23 surface-mount package, '-LT' is a miniature SOT-89/TO243AA transistor package for surface-mount applications; while suffix '-UA' is a three-lead ultra-mini-SIP for through-hole mounting.

## FEATURES

\author{

- Resistant to Physical Stress <br> ■ Superior Temperature Stability <br> - Output Short-Circuit Protection <br> - Operation From Unregulated Supply <br> - Reverse Battery Protection <br> - Solid-State Reliability <br> - Small Size
}

Always order by complete part number: the prefix 'A' + the basic fourdigit part number + a suffix to indicate operating temperature range + a suffix to indicate package style, e.g., A3240ELH.

## FUNCTIONAL BLOCK DIAGRAM




Suffix '-LH' Pinning


115 Northeast Cutoff, Box 15036
Worcester, Massachusetts 01615-0036 (508) 853-5000
Copyright © 1999, Allegro MicroSystems, Inc.

## ELECTRICAL CHARACTERISTICS over operating temperature range.

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Supply Voltage Range | $\mathrm{V}_{\mathrm{CC}}$ | Operating, $\mathrm{T}_{\mathrm{J}}<170^{\circ} \mathrm{C} 1$ | 4.2 | - | 24 | V |
| Output Leakage Current | $\mathrm{I}_{\text {OFF }}$ | $\mathrm{V}_{\text {OUT }}=24 \mathrm{~V}, \mathrm{~B}<\mathrm{B}_{\text {RP }}$ | - | - | 10 | $\mu \mathrm{A}$ |
| Output Saturation Voltage | $\mathrm{V}_{\text {OUT(SAT) }}$ | $\mathrm{I}_{\text {OUT }}=20 \mathrm{~mA}, \mathrm{~B}>\mathrm{B}_{\text {OP }}$ | - | 185 | 500 | mV |
| Output Current Limit | $\mathrm{I}_{\text {OM }}$ | $\mathrm{B}>\mathrm{B}_{\mathrm{OP}}$ | 30 | - | 50 | mA |
| Power-On Time | $t_{\text {po }}$ | $\mathrm{V}_{\mathrm{CC}}>4.2 \mathrm{~V}$ | - | - | 50 | $\mu \mathrm{s}$ |
| Chopping Frequency | $\mathrm{f}_{\mathrm{C}}$ |  | - | 340 | - | kHz |
| Output Rise Time | $\mathrm{t}_{\mathrm{r}}$ | $\mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 0.2 | 2.0 | $\mu \mathrm{s}$ |
| Output Fall Time | $\mathrm{t}_{\mathrm{f}}$ | $\mathrm{R}_{\mathrm{L}}=820 \Omega, \mathrm{C}_{\mathrm{L}}=20 \mathrm{pF}$ | - | 0.1 | 2.0 | $\mu \mathrm{s}$ |
| Supply Current | $I_{\text {cc }}$ | $\mathrm{B}<\mathrm{B}_{\mathrm{RP}}, \mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | - | 3.0 | 6.0 | mA |
|  |  | $\mathrm{B}>\mathrm{B}_{\mathrm{OP}}, \mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ | - | 4.0 | 6.0 | mA |
| Reverse Battery Current | $\mathrm{I}_{\mathrm{Cc}}$ | $V_{R C C}=-30 \mathrm{~V}$ | - | - | -5.0 | mA |
| Zener Voltage | $\mathrm{V}_{\mathrm{z}}$ | $\mathrm{I}_{\mathrm{ZT}}=100 \mu \mathrm{~A}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | 27 | 32 | - | V |
| Zener Impedance | $\mathrm{z}_{\mathrm{z}}$ | $\mathrm{I}_{\mathrm{ZT}}=10 \mathrm{~mA}, \mathrm{~T}_{\mathrm{A}}=25^{\circ} \mathrm{C}$ | - | 50 | - | $\Omega$ |

NOTES: 1. Maximum voltage must be adjusted for power dissipation and junction temperature.
2. $\mathrm{B}_{\mathrm{OP}}=$ operate point (output turns ON ); $\mathrm{B}_{\mathrm{RP}}=$ release point (output turns OFF ).
3. Typical Data is at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ and is for design information only.

MAGNETIC CHARACTERISTICS over operating supply voltage and temperature ranges.

| Characteristic | Symbol | Test Conditions | Limits |  |  |  |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  | Min. | Typ. | Max. | Units |
| Operate Point | $\mathrm{B}_{\mathrm{OP}}$ |  | - | 35 | 50 | G |
| Release Point | $\mathrm{B}_{\mathrm{RP}}$ |  | 5.0 | 25 | - | G |
| Hysteresis | $\mathrm{B}_{\text {hys }}$ | $\mathrm{B}_{\mathrm{OP}}-\mathrm{B}_{\mathrm{RP}}$ | - | 10 | - | G |

[^0]
## TYPICAL OPERATING CHARACTERISTICS as a function of temperature

SWITCH POINTS


## OUTPUT SATURATION VOLTAGE



Dwg. GH-029-4

SUPPLY CURRENT


Dwg. GH-028-5

* Complete part number includes a suffix denoting operating temperature range (E or L) and package type (LH, LT, or UA).


# TYPICAL OPERATING CHARACTERISTICS as a function of supply voltage 

SWITCH POINTS


## OUTPUT SATURATION VOLTAGE



SUPPLY CURRENT


* Complete part number includes a suffix denoting operating temperature range ( E or L ) and package type (LH, LT, or UA).


## SENSOR LOCATIONS

( $\pm 0.005^{\prime \prime}$ [ 0.13 mm$]$ die placement)

Package Designator "LH"


## Package Designator "LT"



Dwg. MH-008-8
Package Designators "UA" and "UA-TL"


Dwg. MH-011-9A

Although sensor location is accurate to three sigma for a particular design, product improvements may result in small changes to sensor location.

115 Northeast Cutoff, Box 15036

## CRITERIA FOR DEVICE QUALIFICATION

All Allegro sensors are subjected to stringent qualification requirements prior to being released to production. To become qualified, except for the destructive ESD tests, no failures are permitted.

| Qualification Test | Test Method and Test Conditions | Test Length | Samples | Comments |
| :---: | :---: | :---: | :---: | :---: |
| Biased Humidity (HAST) | $T_{A}=130^{\circ} \mathrm{C}, \mathrm{RH}=85 \%$ | 50 hrs | 77 | $\mathrm{V}_{\text {CC }}=\mathrm{V}_{\text {OUT }}=5 \mathrm{~V}$ |
| High-Temperature <br> Operating Life (HTOL) | $\begin{aligned} & \text { JESD22-A108, } \\ & \mathrm{T}_{\mathrm{A}}=150^{\circ} \mathrm{C}, \mathrm{~T}_{\mathrm{J}}=170^{\circ} \mathrm{C} \\ & \hline \end{aligned}$ | 408 hrs | 77 | $\begin{aligned} & V_{\text {CC }}=24 \mathrm{~V}, \\ & \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V} \end{aligned}$ |
| Accelerated HTOL | $\begin{aligned} & \text { JESD22-A108, } \\ & \mathrm{T}_{\mathrm{A}}=175^{\circ} \mathrm{C}, \mathrm{~T}_{\mathrm{J}}=190^{\circ} \mathrm{C} \end{aligned}$ | 504 hrs | 77 | $\begin{aligned} & V_{\mathrm{CC}}=24 \mathrm{~V}, \\ & \mathrm{~V}_{\text {OUT }}=20 \mathrm{~V} \end{aligned}$ |
| Autoclave, Unbiased | $\begin{aligned} & \text { JESD22-A102, Condition C, } \\ & \mathrm{T}_{\mathrm{A}}=121^{\circ} \mathrm{C}, 15 \mathrm{psig} \end{aligned}$ | 96 hrs | 77 |  |
| High-Temperature (Bake) Storage Life | MIL-STD-883, Method 1008, $\mathrm{T}_{\mathrm{A}}=170^{\circ} \mathrm{C}$ | 1000 hrs | 77 |  |
| Temperature Cycle | MIL-STD-883, Method 1010, $-65^{\circ} \mathrm{C}$ to $+150^{\circ} \mathrm{C}$ | 500 cycles | 77 |  |
| Latch-Up | - | Pre/Post Reading | 6 |  |
| Electro-Thermally Induced Gate Leakage | - | Pre/Post <br> Reading | 6 |  |
| ESD, <br> Human Body Model | CDF-AEC-Q100-002 | Pre/Post Reading | x per test | Test to failure, All leads > TBD |
| Electrical Distributions | Per Specification | - | 30 |  |

FUNCTIONAL DESCRIPTION

Chopper-Stabilized Technique. These devices use a proprietary dynamic offset cancellation technique, with an internal high-frequency clock to reduce the residual offset voltage of the Hall element that is normally caused by device overmolding, temperature dependencies, and thermal stress. This technique produces devices that have an extremely stable quiescent Hall output voltage, are immune to thermal stress, and have precise recoverability after temperature cycling. This technique will also slightly degrade the device output repeatability.

The Hall element can be considered as a resistor array similar to a Wheatstone bridge. A large portion of the offset is a result of the mismatching of these resistors. The chopperstabilizing technique cancels the mismatching of the resistors by changing the direction of the current flowing through the Hall plate and Hall voltage measurement taps, while maintaining the Hall-voltage signal that is induced by the external magnetic flux. The signal is, then, captured by a sample-and-hold circuit.

Operation. The output of these devices switches low (turns ON) when a magnetic field (south pole) perpendicular to the Hall sensor exceeds the operate point threshold $\left(\mathrm{B}_{\mathrm{OP}}\right)$. After turn-ON, the output is capable of sinking 25 mA and the output voltage is $\mathrm{V}_{\text {OUT(SAT) }}$. When the magnetic field is reduced below the release point ( $\mathrm{B}_{\mathrm{RP}}$ ), the device output goes high (turns OFF). The difference in the magnetic operate and release points is the hysteresis ( $\mathrm{B}_{\mathrm{hys}}$ ) of the device. This built-in hysteresis allows clean switching of the output even in the presence of external mechanical vibration and electrical noise.

Applications. It is strongly recommended that an external bypass capacitor be connected (in close proximity to the Hall sensor) between the supply and ground of the device to reduce both external noise and noise generated by the chopperstabilization technique.

The simplest form of magnet that will operate these devices is a bar magnet with the south pole towards the branded surface of the device. Many other methods of operation are possible. Extensive applications information on magnets and Hall-effect sensors is also available in the Allegro Electronic Data Book AMS-702 or Application Note 27701, or at www.allegromicro.com




## PACKAGE DESIGNATOR 'LH'

(fits SC-74A solder-pad layout)

Dimensions in Inches
(for reference only)


Dwg. MA-010-3 mm


Dwg. MA-011-3 in

NOTES: 1. Tolerances on package height and width represent allowable mold offsets. Dimensions given are measured at the widest point (parting line).
2. Exact body and lead configuration at vendor's option within limits shown.
3. Height does not include mold gate flash.
4. Where no tolerance is specified, dimension is nominal.

## PACKAGE DESIGNATOR 'LT'

(SOT-89/TO-243AA)

Dimensions in Inches
(for reference only)

Dimensions in Millimeters
(controlling dimensions)


Dwg. MA-009-3 mm

ads 1, 2, 3, and A - Standard SOT-89 Layout
ads 1, 2, 3, and B-Low-Stress Version
ads 1, 2, and 3 only - Lowest Stress, But Not Self Aligning
Dwg. MA-012-3 in


Pads 1, 2, 3, and A - Standard SOT-89 Layout
Pads 1, 2, 3, and B - Low-Stress Version
Pads 1, 2, and 3 only - Lowest Stress, But Not Self Aligning
Dwg. MA-012-3 mm

NOTE: Exact body and lead configuration at vendor's option within limits shown.

## PACKAGE DESIGNATOR 'UA'

Dimensions in Inches (controlling dimensions)


Dimensions in Millimeters
(for reference only)


Surface-Mount Lead Form (Suffix '-TL')


NOTES: 1. Tolerances on package height and width represent allowable mold offsets. Dimensions given are measured at the widest point (parting line).
2. Exact body and lead configuration at vendor's option within limits shown.
3. Height does not include mold gate flash.
4. Recommended minimum PWB hole diameter to clear transition area is 0.035 " $(0.89 \mathrm{~mm})$.
5. Where no tolerance is specified, dimension is nominal.

Allegro MicroSystems, Inc. reserves the right to make, from time to time, such departures from the detail specifications as may be required to permit improvements in the design of its products.

The information included herein is believed to be accurate and reliable. However, Allegro MicroSystems, Inc. assumes no responsibility for its use; nor for any infringements of patents or other rights of third parties which may result from its use.



[^0]:    NOTES: 1. Complete part number includes a suffix to identify operating temperature range ( E or L ) and package type (LH, LT, or UA).
    2. Typical Data is at $\mathrm{T}_{\mathrm{A}}=+25^{\circ} \mathrm{C}$ and $\mathrm{V}_{\mathrm{CC}}=12 \mathrm{~V}$ and is for design information only.

